TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC374AP,TC74HC374AF

Octal D-Type Flip-Flop with 3-State Output

The TC74HC374A is a high speed CMOS OCTAL FLIP-FLOP with 3-STATE OUTPUT fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

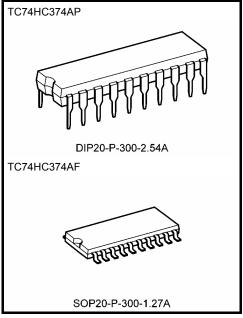
These 8-bit D-type flip-flops are controlled by a clock input (CK) and an output enable input (\overline{OE}).

When the $\overline{\text{OE}}$ input is high, the eight outputs are in a high impedance state.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

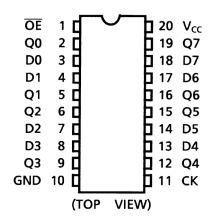
- High speed: $f_{max} = 77 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: I_{CC} = 4 μA (max) at Ta = 25°C
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: |IOH| = IOL = 6 mA (min)
- Balanced propagation delays: $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 to 6 V
- Pin and function compatible with 74LS374



Weight

DIP20-P-300-2.54A : 1.30 g (typ.) SOP20-P-300-1.27A : 0.22 g (typ.)

Pin Assignment



IEC Logic Symbol

OE (1) CK (11)	EN > C 1	
D0 (3) D1 (4) D2 (7)	1D ▷ ▽	(2) Q0 (5) Q1 (6) Q2
D3 (8)		<u>(9)</u> 03
D5 (14) D6 (17)		(12) Q4 (15) Q5 (16) Q6 (19) 07
D7 (10)		(13) Q7

Truth Table

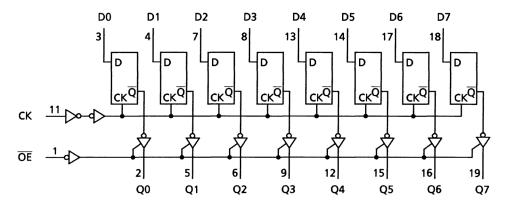
	Outputs		
ŌĒ	CK	D	Q
Н	Х	Х	Z
L	\rightarrow	Х	Qn
L		L	L
L		Н	Н

X: Don't care

Z: High impedance

Q_n: No change

System Diagram



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Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	–0.5 to 7	V
DC input voltage	V _{IN}	−0.5 to V _{CC} + 0.5	V
DC output voltage	V _{OUT}	−0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±35	mA
DC V _{CC} /ground current	Icc	±75	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	–65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to $65^{\circ}C$. From Ta = 65 to $85^{\circ}C$ a derating factor of -10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2 to 6	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	V _{OUT}	0 to V _{CC}	٧
Operating temperature	T _{opr}	−40 to 85	°C
		0 to 1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0 to 500 (V _{CC} = 4.5 V)	ns
		0 to 400 (V _{CC} = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

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Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition		Test Condition Ta = 25°C			Ta –40 to	Unit			
	.,			V _{CC} (V)	Min	Тур.	Max	Min	Max		
				2.0	1.50	_	_	1.50	_		
High-level input voltage	V_{IH}		_	4.5	3.15		_	3.15	_	V	
				6.0	4.20	_	_	4.20	_		
				2.0	_		0.50	_	0.50		
Low-level input voltage	V_{IL}		_	4.5	_	_	1.35	_	1.35	V	
Ţ.				6.0	_	_	1.80	—	1.80		
				2.0	1.9	2.0	_	1.9	_		
			$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_		
High-level output voltage	Voн	V _{IN} = V _{IH} or V _{IL}		6.0	5.9	6.0	_	5.9	_	V	
			I _{OH} = -6 mA	4.5	4.18	4.31	_	4.13	_		
			$I_{OH} = -7.8 \text{ mA}$	6.0	5.68	5.80	_	5.63	_		
					2.0	_	0.0	0.1	_	0.1	
		V _{OL} V _{IN} = V _{IH} or V _{IL}	$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1		
Low-level output voltage	t V _{OL}			6.0	_	0.0	0.1	_	0.1	V	
		11110111	I _{OL} = 6 mA	4.5	_	0.17	0.26	_	0.33		
			I _{OL} = 7.8 mA	6.0	_	0.18	0.26	_	0.33		
3-state output		$V_{IN} = V_{IH}$ or	V _{IL}	6.0			.0.5		15.0	^	
off-state current	l _{OZ}	V _{OUT} = V _{CC} or GND		6.0	_	_ _	±0.5	_	±5.0	μΑ	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0	_	_	±0.1	_	±1.0	μА	
Quiescent supply current	Icc	V _{IN} = V _{CC} or	r GND	6.0	_	_	4.0	_	40.0	μА	

Timing Requirements (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	Ta =	Ta = 25°C		Unit	
			V _{CC} (V)	Тур.	Limit	Limit	
Minimum nulao width	5 a.u.		2.0	_	75	95	
Minimum pulse width	t _{W (H)}	_	4.5	_	15	19	ns
(CK)	t _{W (L)}		6.0	_	13	16	
Minimum out up time			2.0	_	75	95	
Minimum set-up time (Dn)	ts	_	4.5	_	15	19	ns
(DII)			6.0	_	13	16	
Minimum hold time			2.0	_	0	0	
	t _h	_	4.5	_	0	0	ns
(Dn)			6.0	_	0	0	
			2.0	_	6	5	
Clock frequency	f	_	4.5	_	31	25	MHz
			6.0	_	36	29	



AC Characteristics (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Co	ndition	_	-	Га = 25°C			a = 0 85°C	Unit	
	- ,		CL (pF)	V _{CC} (V)	Min	Тур.	Max	Min	Max		
	4			2.0	_	20	60	_	75		
Output transition time	t _{TLH}	_	50	4.5	_	6	12	_	15	ns	
	t _{THL}			6.0	_	5	10	_	13		
				2.0	_	45	140	_	175		
			50	4.5	_	15	28	_	35		
Propagation delay time	t_{pLH}			6.0	_	13	24	_	30	20	
(CK-Q)	t_{pHL}	_		2.0	_	60	190	_	240	ns	
(3.1 1)			150	4.5	_	20	38	_	48		
				6.0	_	17	32	_	41		
	t _p zL				2.0	_	39	135	_	170	
		D. 4 kg	50	4.5	_	13	27	_	34	20	
Output anabla tima				6.0	_	11	23	_	29		
Output enable time	t_{pZH}	$R_L = 1 \text{ k}\Omega$		2.0	_	54	185	_	230	ns	
			150	4.5	_	18	37	_	46		
				6.0	_	15	31	_	39		
				2.0	_	30	135	_	170		
Output enable time	t _{pLZ}	$R_L = 1 \text{ k}\Omega$	50	4.5	_	13	27	_	34	ns	
	t _{pHZ}			6.0	_	12	23	_	29		
				2.0	6	18	_	5	_		
Maximum clock frequency	f _{max}	_	50	4.5	31	75	_	25	_	MHz	
				6.0	36	90	_	29	_		
Input capacitance	C _{IN}	_	-		_	5	10		10	pF	
Output capacitance	C _{OUT}	_	-		_	10	_	_	_	pF	
Power dissipation capacitance	C _{PD} (Note)	_	_		_	47	_	_	_	pF	

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

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Average operating current can be obtained by the equation:

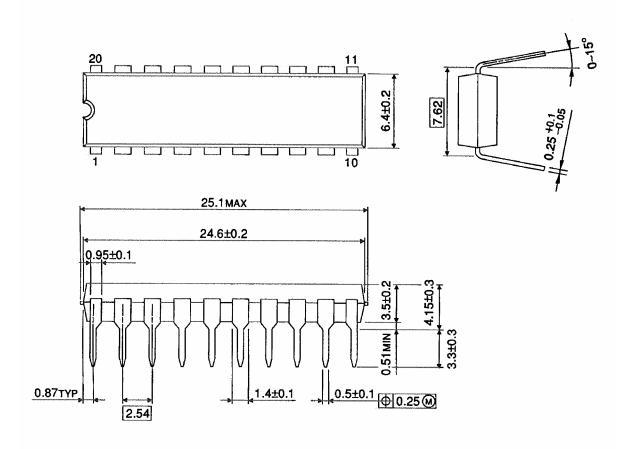
$$I_{CC} \text{ (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per flip flop)}$$

And the total C_{PD} when n pcs. of F/F operate can be gained by the following equation:

$$C_{PD}$$
 (total) = 30 + 17 · n

Package Dimensions

DIP20-P-300-2.54A Unit: mm



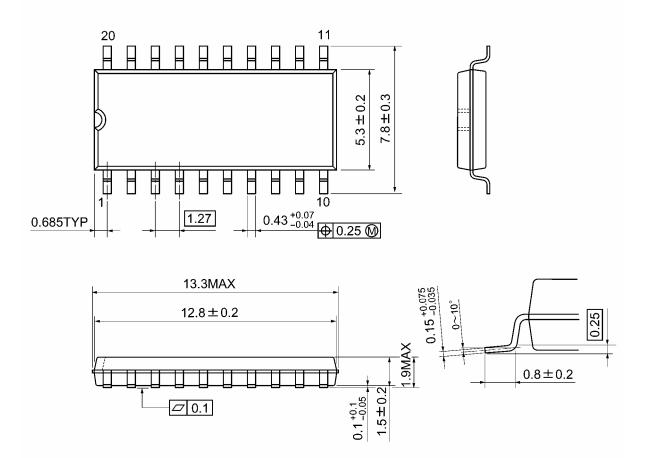
6

Weight: 1.30 g (typ.)



Package Dimensions

SOP20-P-300-1.27A Unit: mm



Weight: 0.22 g (typ.)

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20070701-EN GENERAL

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